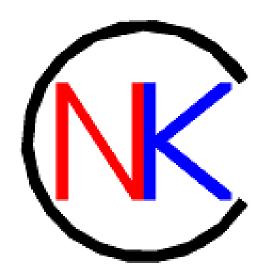
[APPROVAL SHEET]

Nice Korea Components



Antenna Solution company

Nice Korea Components Co., Ltd

TEL: 031-470-8989

FAX: 031-470-8949



[APPROVAL SHEET]

Product	Chip M-type Antenna			
Model	NKC245	50-M00		
Designed by	Checked by Approved by			
Alg				
7/19	7/19	7/19		

2010. 7. 19

Nice Korea Components Co., Ltd

TEL: 031-470-8989

FAX: 031-470-8949



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1. Revision History

product	Chip M-type Antenna Model		NKC2450-M00			
Rev. No.	Rev. Issue	Pa	ge	De	signed	Date
1.0	Appro. Issue	_	-	KC	C. NAM	2009.7.20
1.1	revision	То	tal	KC	C. NAM	2010.7.19



2. Features & Applications

2.1 Features

This ceramic chip antenna is applied to 2.4 GHz ISM band applications, i.e. Bluetooth. Zigbee, Wireless LAN, etc...

형태	Bulk Ceramic		
-11 -1	유전체	Al2O3(Alumina)	
재질	전극	은(Ag)	
크기 (mm)	L = 10+/- 0.1		
	W = 2 + / - 0.1	BNKC	
	T = 1.2+/- 0.1		
Version	Revision 1.1		



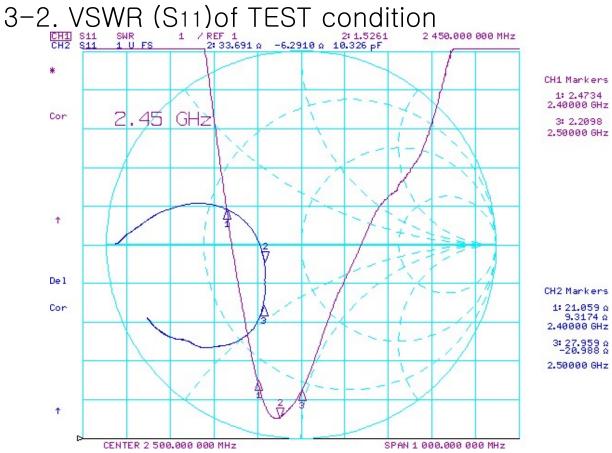
3. Electrical Specifications

3-1.

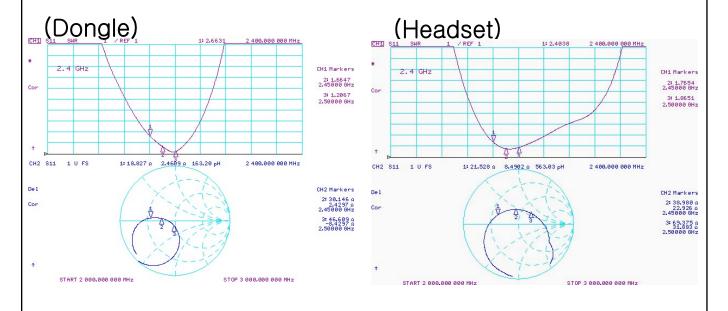
- * All item are measured in room temperature (24~25 'C).
- * All item are measured at customer set condition.

No.	Items	Typical Data
1	Frequency (MHz)	2400 ~2485
2	VSWR	2:1
3	Total Gain (Peak/AVG.) [dBi]	0.19 / -1.82
4	Impedance	50 ohm
5	Polarization	Linear



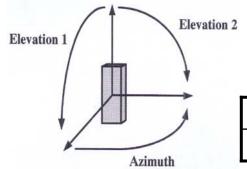


3-3. VSWR (S11) of SET condition



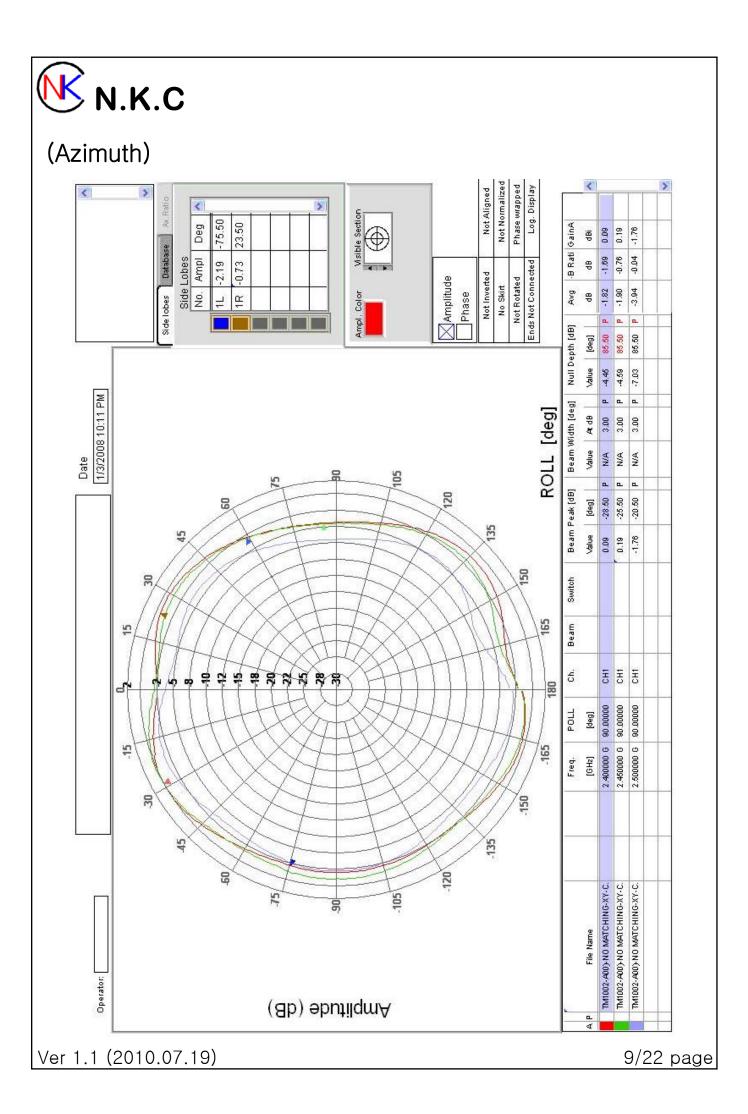


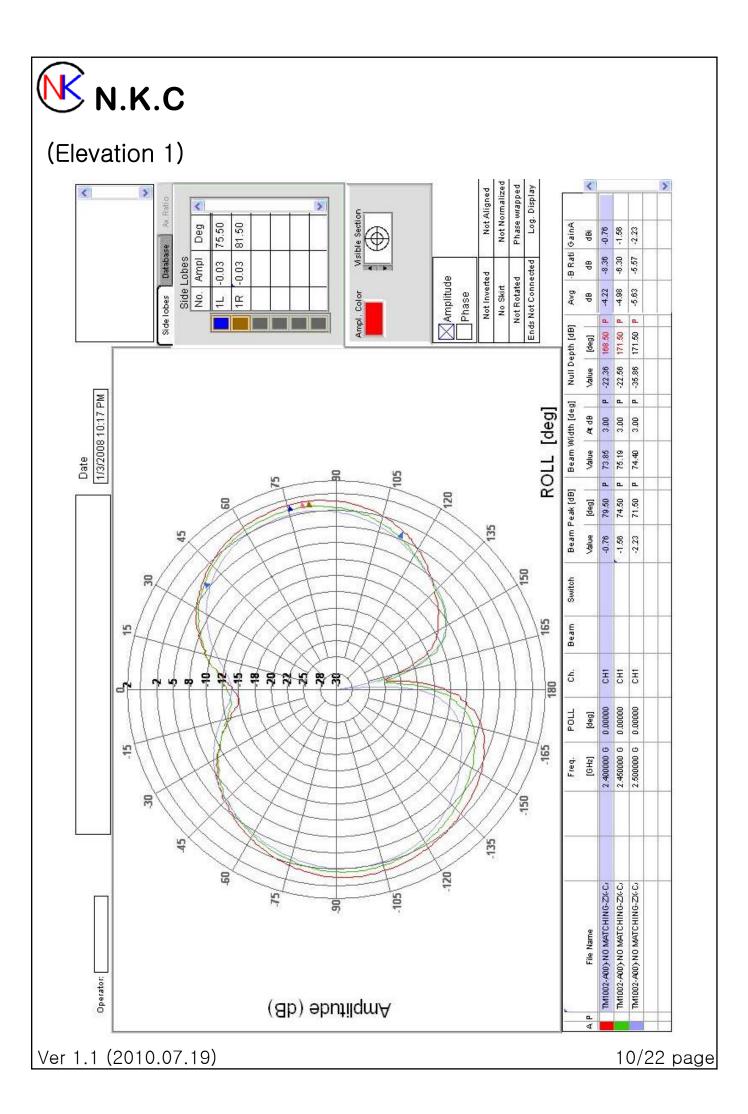
3-4. Radiation Patterns

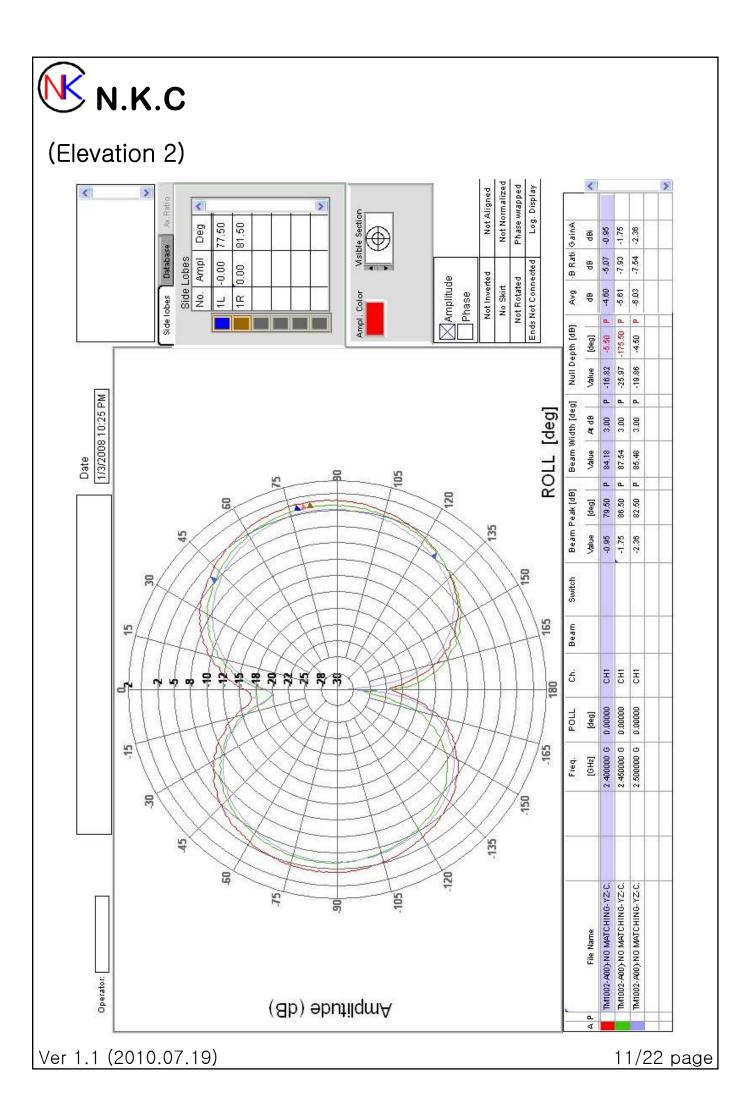


Theta	Ve rtical Field of measured plane
Phi	Horizontal Field of measured plane

	Total Gain (Peak/Avg) [dBi]	0.19 / -1.82	
이득[dBi] (Co-Pola)	Azimuth	Phi	Peak	0.19
			Avg	-1.82
	Elevation 1	Theta	Peak	-0.76
			Avg	-4.22
	Elevation 2	Theta	Peak	-0.95
			Avg	-4.60





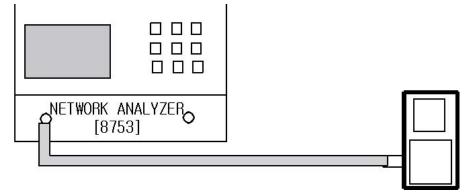




4. Measurements Method & Conditions

The measurement of antenna performance is measurement of gain, radiation pattern using ORBIT/FR apparatus in Anechoic chamber and measurement of VSWR using Network analyzer.

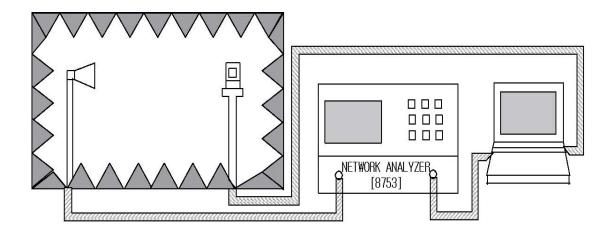
4-1. The measurement of Frequency and VSWR



[Measurement Method]

- 1. As seen the above, network analyzer is set up for S11 measurement.
- 2. The measurement frequency range is to set up from 2 GHz to 3 GHz.
- 3. Perform S11 one port full calibration.
- 4. Measure the VSWR of three points of Bluetooth frequency range such as 2.4 GHz, 2.45 GHz, and 2.5 GHz.

4-2. The measurement of Gain & Radiation Patterns



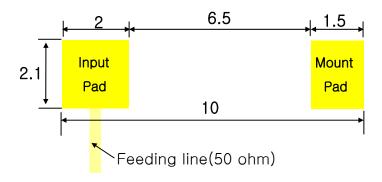


[Measurement Method]

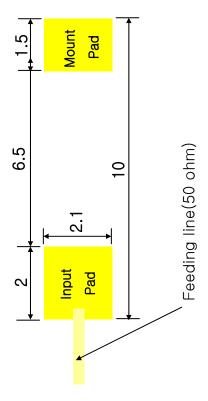
- 1. As seen the above, network analyzer is to set up in Anechoic chamber.
- 2. As seen beneath, for the measurement planes as Azimuth, Elevation 1, and Elevation 2, measure Gain data of vertical polarization and horizontal polarization for each plane.

5. PCB Layout & Solder Pad size

5-1. Top Layout



5-2. Top Layout



Unit: mm

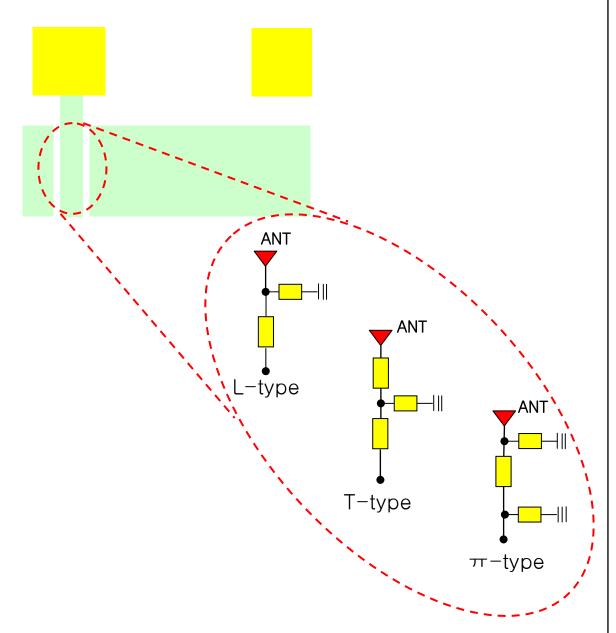
tolerances: +/-0.05

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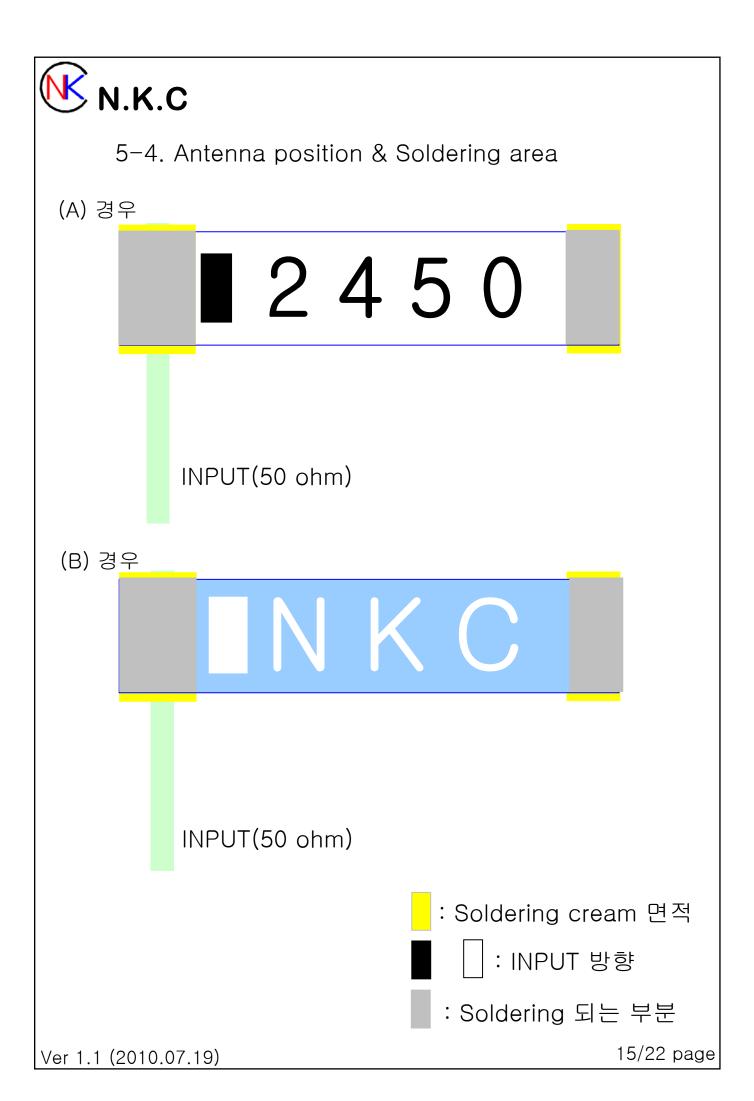


5-3. Matching Circuits



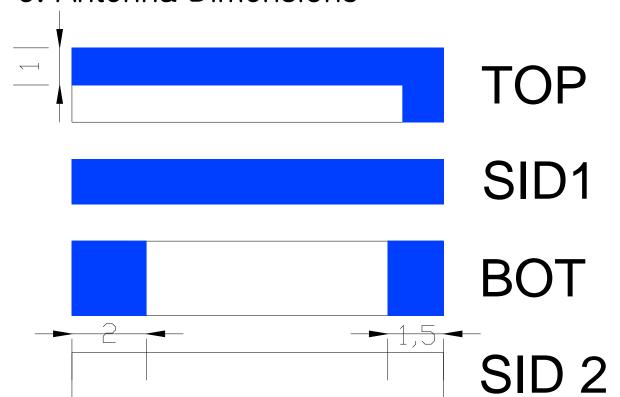
- (1) 실제 적용되는 Board의 GND SIZE 및 형태에 따른 Impedance 조정,
- (2) 설계된 전송선의 50 ohm miss-matching시 Impedance 조정,
- (3) 안테나 자체의 부족한 Impedance 조정,
- (4) 이 이외의 다른 변화에 따른 특성 조정에 Lumped elements 사용 시 3가지 종류 중 한가지의 matching circuit을 적용함.

Matching circuit 적용 시 matching circuit이 차지하는 면적 및 가장 좋은 결과를 얻을 수 있는 matching type를 선택함.

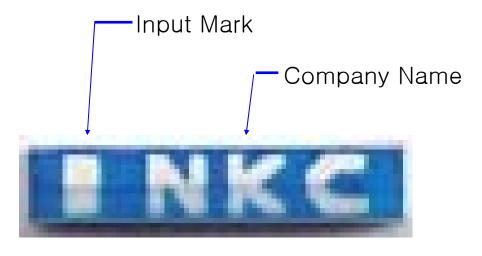




6. Antenna Dimensions



7. Marking View



7-1. 마킹 종류

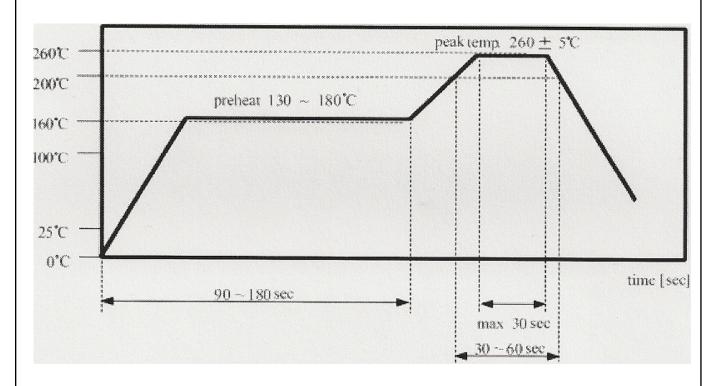
* RF용 파랑(검정) 잉크 사용

Ver 1.1 (2010.07.19)



8. Reflow Profile

8-1. Standard reflow condition



8-2. 수동 납땜 (인두기)을 할 경우

예열: 120 'C / 시간: 60 ~ 300 sec

인두 온도: 340 'C / 시간: 각 단 max 3 sec



9. Environmental Tests

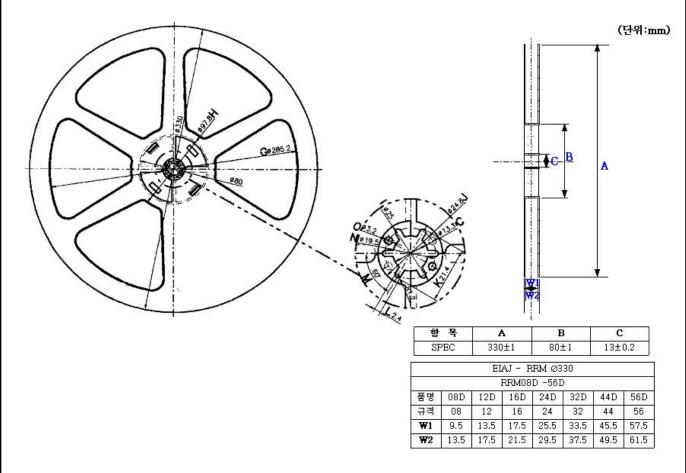
No.	Item	Test Conditions
1	High Temperature Storage	Leave for 72+/-2 hours in a test bath retaining 85+/-2'C. After then, leave on the test condition for 1.5 hours.
2	Low Temperature Storage	Leave for 72+/-2 hours in a test bath retaining -30+/-2'C. After then, leave on the test condition for 1.5 hours.
3	Static Humidity	Leave for 24+/-2 hours in test bath retaining 90-90% RH/50+/-3'C. After then, leave in the test condition for 1.5 hours.
4	Thermal Shock	Cool from 25'C down to -30+/-2'C and leave for 30 minutes. After that, heat up to 85+/-2'C and leave for 30 minutes. After then, cool down to 25'C. Repeat the cycle 15 time and leave on the test conditions for 1.5 hours.
5	Drop Shock	Drop 150g weight onto steel floor from the height of 152cm, 19 times and 120cm, 12 times.
6	Vibration	With 5g of the whole acceleration at 20 to 2000 Hz, apply a vibration for 2 hours for each of 3 directions.
7	Solder Proof	No reaching after reflow for 5+/- sec at 260'C.



10. Packaging

10-1. Reel Taping Quantity 8,000 pcs / 1 reel

10-2. Carrier Tape & Reel Dimensions



11. Usage and Cautions

Safe-keeping conditions: 1 months in 20+/-15'C & less than 60%



12. RoHS Data

(1) Ceramic Power

시험성적서

한 국 세 라 믹 기 술 원 위153-801 서울시 금천구 가산동 233-5

(Tel: 02 3282 2416/7, Fax: 02 3282 2418)

성적서번호 : 2010-0262

페이지 (1)/(총 1)



1. 의 뢰 자

ㅇ 기관명/성명 : 해동세라믹 / 김원식

주 소 : 경기도 화성시 장안면 석포리 681-13,14

의 뢰 일 자 : 2010 년 02월 04일2. 시험성적서의 용도 : 품질관리

3. 시험 시료명/물질 : 세라믹 Base

4. 시험기간 : 2010 년 02월 04일 ~ 2010 년 02월 09일

5. 시험방법: KS C IEC 62321, KS M 1810, KS M 3719, KS D 1662,

KS M 1061: 2007

6. 시험환경 : 온도 : (20~ 22) °C , 상대습도 : (48 ~ 52) % R.H.

7. 시험결과

시료명	시험분석항목	시험분석결과	시험분석방법	비고
세라믹 Base	Pb (mg/Kg)	불검출(<5)	KS C IEC 62321 KS M 1810, EPA 3052	
	Cd (mg/Kg)	불검출(<1)	KS C IEC 62321 KS M 1810, EPA 3052	
	Hg (mg/Kg)	불검출(<1)	KS C IEC 62321 KS M 3719	유사 규격
	Cr ⁶⁺ (mg/Kg)	불검출(<0.1)	KS C IEC 62321 KS D 1662	준용
	PBBs (mg/Kg)	ng/Kg) 불검출 VS M 1061 : 2007		
	PBDs (mg/Kg)	불검출	KS M 1061 : 2007	

참고) 1. 상기 분석에 사용된 ICP-OES는 PERKIN-ELMER사의 OPTIMA 5300 DV임.

2. 상기 분석에 사용된 AAS는 PERKIN-ELMER사의 AAnalyst 700임.

3, 상기 분석에 사용된 GC-MS는 Perkin-Elmer Claus 500 mass. 끝.

확 인 시험자: 김 선 택(2431), 최 기 인(7849) 기술책임자:박 덕 원

2010 . 02 . 10

한국세라믹기술



비고) 이 성척서는 의뢰자가 제시한 시료 및 시료명으로 시험한 평가결과로서 전체 제품에 대한 품질 및 성능을 보증하지 않습니다.

양식-PB-03-05B(4)



(2) Ag Paste







(3) Marking Ink





